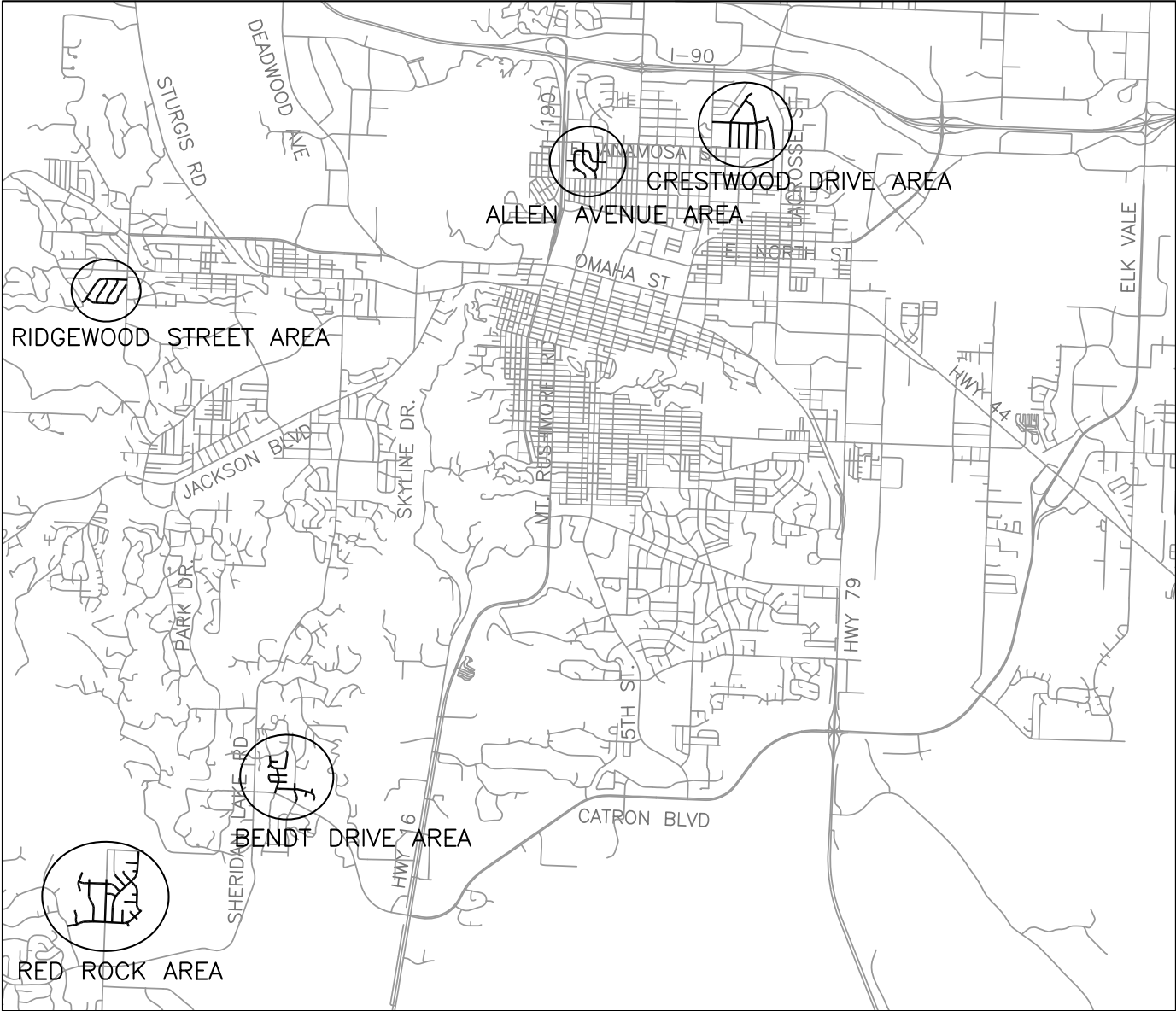


# VICINITY MAP



**2017 CHIP SEALING PROJECT  
PROJECT # 17-2379, CIP 50844**